

## LM62 2.7V, 15.6 mV/°C SOT-23 Temperature Sensor

Check for Samples: [LM62](#)

### FEATURES

- Calibrated Linear Scale Factor of +15.6 mV/°C
- Rated for Full 0°C to +90°C Range with 3.0V Supply
- Suitable for Remote Applications

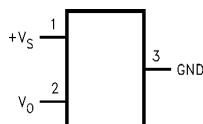
### APPLICATIONS

- Cellular Phones
- Computers
- Power Supply Modules
- Battery Management
- FAX Machines
- Printers
- HVAC
- Disk Drives
- Appliances

### KEY SPECIFICATIONS

- Accuracy at 25°C ±2.0 or ±3.0°C (max)
- Temperature Slope +15.6 mV/°C
- Power Supply Voltage Range +2.7V to +10V
- Current Drain @ 25°C 130 µA (max)
- Nonlinearity ±0.8°C (max)
- Output Impedance 4.7 kΩ (max)

### Connection Diagram



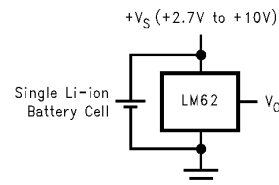
See Package Number DBZ

### DESCRIPTION

The LM62 is a precision integrated-circuit temperature sensor that can sense a 0°C to +90°C temperature range while operating from a single +3.0V supply. The LM62's output voltage is linearly proportional to Celsius (Centigrade) temperature (+15.6 mV/°C) and has a DC offset of +480 mV. The offset allows reading temperatures down to 0°C without the need for a negative supply. The nominal output voltage of the LM62 ranges from +480 mV to +1884 mV for a 0°C to +90°C temperature range. The LM62 is calibrated to provide accuracies of ±2.0°C at room temperature and +2.5°C/–2.0°C over the full 0°C to +90°C temperature range.

The LM62's linear output, +480 mV offset, and factory calibration simplify external circuitry required in a single supply environment where reading temperatures down to 0°C is required. Because the LM62's quiescent current is less than 130 µA, self-heating is limited to a very low 0.2°C in still air. Shutdown capability for the LM62 is intrinsic because its inherent low power consumption allows it to be powered directly from the output of many logic gates.

### Typical Application



$$V_O = (+15.6 \text{ mV/}^\circ\text{C} \times T^\circ\text{C}) + 480 \text{ mV}$$

**Figure 1. Full-Range Centigrade Temp. Sensor (0°C to +90°C) Stabilizing a Crystal Oscillator**

| Temperature (T) | Typical V <sub>O</sub> |
|-----------------|------------------------|
| +90°C           | +1884 mV               |
| +70°C           | +1572 mV               |
| +25°C           | 870 mV                 |
| 0°C             | +480 mV                |



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## Absolute Maximum Ratings<sup>(1)</sup>

|                                                |                  |                                   |
|------------------------------------------------|------------------|-----------------------------------|
| Supply Voltage                                 |                  | +12V to –0.2V                     |
| Output Voltage                                 |                  | (+V <sub>S</sub> + 0.6V) to –0.6V |
| Output Current                                 |                  | 10 mA                             |
| Input Current at any pin <sup>(2)</sup>        |                  | 5 mA                              |
| Storage Temperature                            |                  | –65°C to +150°C                   |
| Junction Temperature, max (T <sub>JMAX</sub> ) |                  | +125°C                            |
| ESD Susceptibility <sup>(3)</sup>              | Human Body Model | 2500V                             |
|                                                | Machine Model    | 250V                              |

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits. For ensured specifications and test conditions, see the Electrical Characteristics. The ensured specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
- (2) When the input voltage (V<sub>I</sub>) at any pin exceeds power supplies (V<sub>I</sub> < GND or V<sub>I</sub> > +V<sub>S</sub>), the current at that pin should be limited to 5 mA.
- (3) The human body model is a 100 pF capacitor discharged through a 1.5 kΩ resistor into each pin. The machine model is a 200 pF capacitor discharged directly into each pin.

## Operating Ratings<sup>(1)</sup>

|                                                                                                                                                                                                   |                                                          |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------|
| Specified Temperature Range                                                                                                                                                                       | <b>T<sub>MIN</sub> ≤ T<sub>A</sub> ≤ T<sub>MAX</sub></b> |
| LM62B, LM62C                                                                                                                                                                                      | 0°C ≤ T <sub>A</sub> ≤ +90°C                             |
| Supply Voltage Range (+V <sub>S</sub> )                                                                                                                                                           | +2.7V to +10V                                            |
| Thermal Resistance, θ <sub>JA</sub> <sup>(2)</sup>                                                                                                                                                | 450°C/W                                                  |
| Soldering process must comply with Texas Instruments' Reflow Temperature Profile specifications.<br>Refer to <a href="http://www.ti.com/packaging">http://www.ti.com/packaging</a> <sup>(3)</sup> |                                                          |

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits. For ensured specifications and test conditions, see the Electrical Characteristics. The ensured specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
- (2) The junction to ambient thermal resistance (θ<sub>JA</sub>) is specified without a heat sink in still air.
- (3) Reflow temperature profiles are different for lead-free and non-lead-free packages.

## Electrical Characteristics

Unless otherwise noted, these specifications apply for  $+V_S = +3.0\text{ V}_{DC}$ . **Boldface limits apply for  $T_A = T_J = T_{MIN}$  to  $T_{MAX}$** ; all other limits  $T_A = T_J = 25^\circ\text{C}$ .

| Parameter                                    | Conditions                                                                                     | Typical <sup>(1)</sup> | LM62B                                                  | LM62C                                                  | Units<br>(Limit)                                         |
|----------------------------------------------|------------------------------------------------------------------------------------------------|------------------------|--------------------------------------------------------|--------------------------------------------------------|----------------------------------------------------------|
|                                              |                                                                                                |                        | Limits <sup>(2)</sup>                                  | Limits <sup>(2)</sup>                                  |                                                          |
| Accuracy <sup>(3)</sup>                      |                                                                                                |                        | $\pm 2.0$                                              | $\pm 3.0$                                              | $^\circ\text{C}$ (max)                                   |
|                                              |                                                                                                |                        | <b><math>+2.5/-2.0</math></b>                          | <b><math>+4.0/-3.0</math></b>                          | $^\circ\text{C}$ (max)                                   |
| Output Voltage at $0^\circ\text{C}$          |                                                                                                | +480                   |                                                        |                                                        | mV                                                       |
| Nonlinearity <sup>(4)</sup>                  |                                                                                                |                        | <b><math>\pm 0.8</math></b>                            | <b><math>\pm 1.0</math></b>                            | $^\circ\text{C}$ (max)                                   |
| Sensor Gain<br>(Average Slope)               |                                                                                                | +16                    | <b><math>+16.1</math></b><br><b><math>+15.1</math></b> | <b><math>+16.3</math></b><br><b><math>+14.9</math></b> | mV/ $^\circ\text{C}$ (max)<br>mV/ $^\circ\text{C}$ (min) |
|                                              |                                                                                                |                        |                                                        |                                                        |                                                          |
| Output Impedance                             | $+3.0\text{V} \leq +V_S \leq +10\text{V}$                                                      |                        | <b>4.7</b>                                             | <b>4.7</b>                                             | k $\Omega$ (max)                                         |
|                                              | $0^\circ\text{C} \leq T_A \leq +75^\circ\text{C}$ , $+V_S = +2.7\text{V}$                      |                        | <b>4.4</b>                                             | <b>4.4</b>                                             | k $\Omega$ (max)                                         |
| Line Regulation <sup>(5)</sup>               | $+3.0\text{V} \leq +V_S \leq +10\text{V}$                                                      |                        | <b><math>\pm 1.13</math></b>                           | <b><math>\pm 1.13</math></b>                           | mV/V (max)                                               |
|                                              | $+2.7\text{V} \leq +V_S \leq +3.3\text{V}$ , $0^\circ\text{C} \leq T_A \leq +75^\circ\text{C}$ |                        | <b><math>\pm 9.7</math></b>                            | <b><math>\pm 9.7</math></b>                            | mV (max)                                                 |
| Quiescent Current                            | $+2.7\text{V} \leq +V_S \leq +10\text{V}$                                                      | 82                     | 130                                                    | 130                                                    | $\mu\text{A}$ (max)                                      |
|                                              |                                                                                                |                        | <b>165</b>                                             | <b>165</b>                                             | $\mu\text{A}$ (max)                                      |
| Change of Quiescent Current                  | $+2.7\text{V} \leq +V_S \leq +10\text{V}$                                                      | $\pm 5$                |                                                        |                                                        | $\mu\text{A}$                                            |
| Temperature Coefficient of Quiescent Current |                                                                                                | 0.2                    |                                                        |                                                        | $\mu\text{A}/^\circ\text{C}$                             |
| Long Term Stability <sup>(6)</sup>           | $T_J = T_{MAX} = +100^\circ\text{C}$ ,<br>for 1000 hours                                       | $\pm 0.2$              |                                                        |                                                        | $^\circ\text{C}$                                         |

- (1) Typicals are at  $T_J = T_A = 25^\circ\text{C}$  and represent most likely parametric norm.
- (2) Limits are ensured to Texas Instruments' AOQL (Average Outgoing Quality Level).
- (3) Accuracy is defined as the error between the output voltage and  $+15.6\text{ mV}/^\circ\text{C}$  times the device's case temperature plus 480 mV, at specified conditions of voltage, current, and temperature (expressed in  $^\circ\text{C}$ ).
- (4) Nonlinearity is defined as the deviation of the output-voltage-versus-temperature curve from the best-fit straight line, over the device's rated temperature range.
- (5) Regulation is measured at constant junction temperature, using pulse testing with a low duty cycle. Changes in output due to heating effects can be computed by multiplying the internal dissipation by the thermal resistance.
- (6) For best long-term stability, any precision circuit will give best results if the unit is aged at a warm temperature, and/or temperature cycled for at least 46 hours before long-term life test begins. This is especially true when a small (Surface-Mount) part is wave-soldered; allow time for stress relaxation to occur. The majority of the drift will occur in the first 1000 hours at elevated temperatures. The drift after 1000 hours will not continue at the first 1000 hour rate.

## Typical Performance Characteristics

To generate these curves the LM62 was mounted to a printed circuit board as shown in [Figure 12](#).

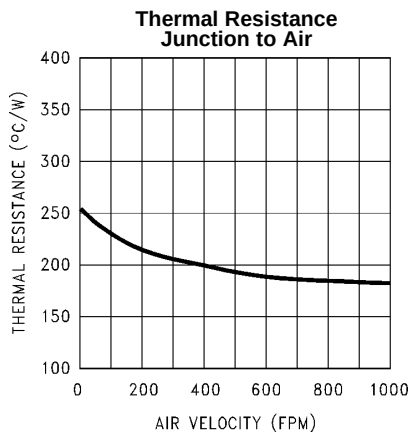


Figure 2.

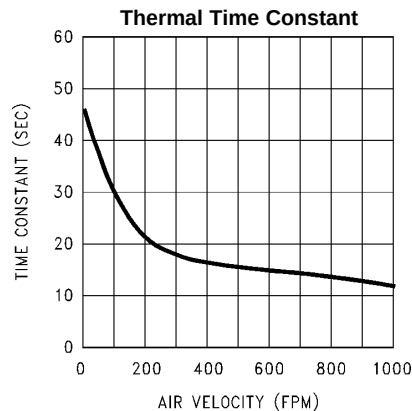


Figure 3.

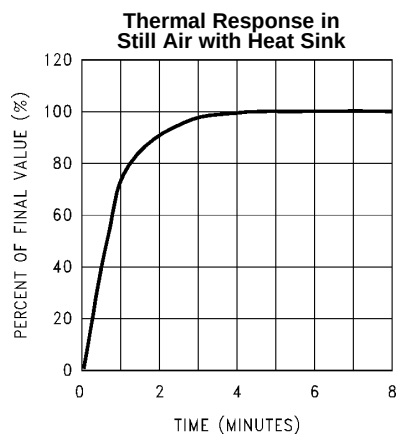


Figure 4.

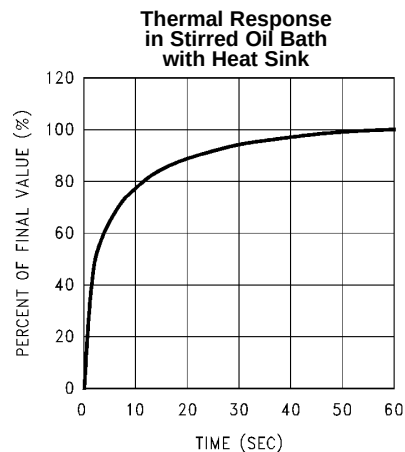


Figure 5.

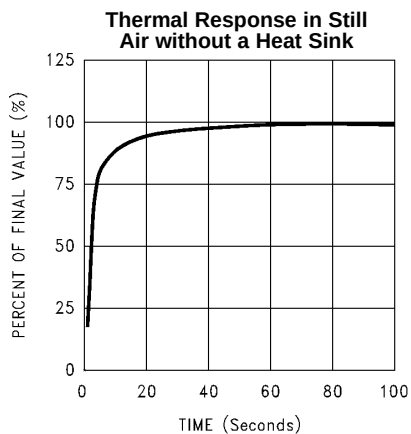


Figure 6.

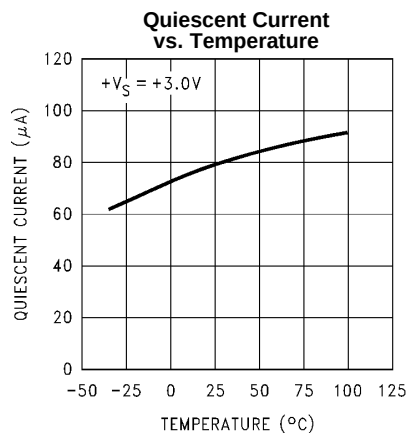


Figure 7.

## Typical Performance Characteristics (continued)

To generate these curves the LM62 was mounted to a printed circuit board as shown in [Figure 12](#).

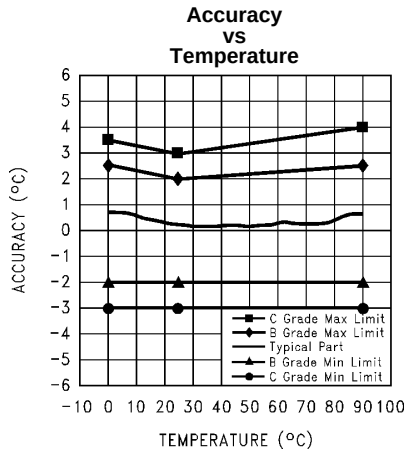


Figure 8.

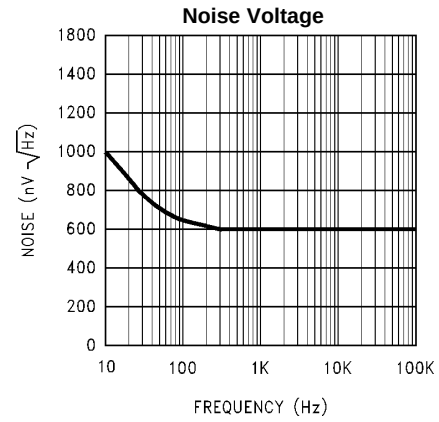


Figure 9.

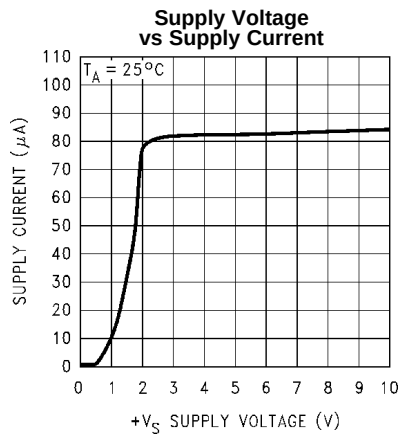


Figure 10.

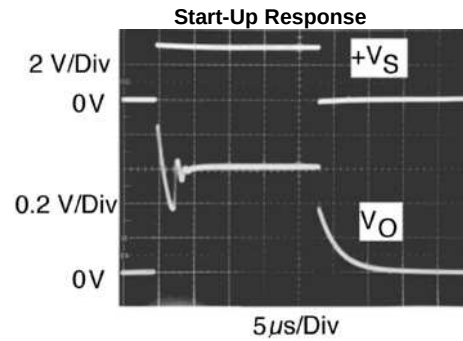
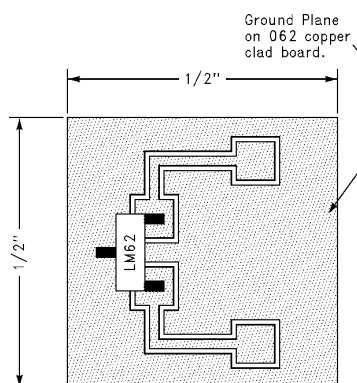


Figure 11.

### CIRCUIT BOARD



1/2" Square Printed Circuit Board with 2 oz. Copper Foil or Similar.

**Figure 12. Printed Circuit Board Used for Heat Sink to Generate All Curves**

### Mounting

The LM62 can be applied easily in the same way as other integrated-circuit temperature sensors. It can be glued or cemented to a surface. The temperature that the LM62 is sensing will be within about +0.2°C of the surface temperature that LM62's leads are attached to.

This presumes that the ambient air temperature is almost the same as the surface temperature; if the air temperature were much higher or lower than the surface temperature, the actual temperature measured would be at an intermediate temperature between the surface temperature and the air temperature.

To ensure good thermal conductivity the backside of the LM62 die is directly attached to the GND pin. The lands and traces to the LM62 will, of course, be part of the printed circuit board, which is the object whose temperature is being measured. These printed circuit board lands and traces will not cause the LM62's temperature to deviate from the desired temperature.

Alternatively, the LM62 can be mounted inside a sealed-end metal tube, and can then be dipped into a bath or screwed into a threaded hole in a tank. As with any IC, the LM62 and accompanying wiring and circuits must be kept insulated and dry, to avoid leakage and corrosion. This is especially true if the circuit may operate at cold temperatures where condensation can occur. Printed-circuit coatings and varnishes such as Humiseal and epoxy paints or dips are often used to ensure that moisture cannot corrode the LM62 or its connections.

The thermal resistance junction to ambient ( $\theta_{JA}$ ) is the parameter used to calculate the rise of a device junction temperature due to its power dissipation. For the LM62 the equation used to calculate the rise in the die temperature is as follows:

$$T_J = T_A + \theta_{JA} [(+V_S I_Q) + (+V_S - V_O) I_L] \quad (1)$$

where  $I_Q$  is the quiescent current and  $I_L$  is the load current on the output. Since the LM62's junction temperature is the actual temperature being measured care should be taken to minimize the load current that the LM62 is required to drive.

The table shown in [Table 1](#) summarizes the rise in die temperature of the LM62 without any loading, and the thermal resistance for different conditions.

**Table 1. Temperature Rise of LM62 Due to Self-Heating and Thermal Resistance ( $\theta_{JA}$ )**

|            | SOT-23<br>no heat sink <sup>(1)</sup> |                     | SOT-23<br>small heat fin <sup>(2)</sup> |                     |
|------------|---------------------------------------|---------------------|-----------------------------------------|---------------------|
|            | $\theta_{JA}$<br>(°C/W)               | $T_J - T_A$<br>(°C) | $\theta_{JA}$<br>(°C/W)                 | $T_J - T_A$<br>(°C) |
| Still air  | 450                                   | 0.17                | 260                                     | 0.1                 |
| Moving air |                                       |                     | 180                                     | 0.07                |

(1) Part soldered to 30 gauge wire.

(2) Heat sink used is 1/2" square printed circuit board with 2 oz. foil with part attached as shown in [Figure 12](#).

The LM62 handles capacitive loading well. Without any special precautions, the LM62 can drive any capacitive load as shown in [Figure 13](#). Over the specified temperature range the LM62 has a maximum output impedance of 4.7 k $\Omega$ . In an extremely noisy environment it may be necessary to add some filtering to minimize noise pickup. It is recommended that 0.1  $\mu$ F be added from +V<sub>S</sub> to GND to bypass the power supply voltage, as shown in [Figure 14](#). In a noisy environment it may be necessary to add a capacitor from the output to ground. A 1  $\mu$ F output capacitor with the 4.7 k $\Omega$  maximum output impedance will form a 34 Hz lowpass filter. Since the thermal time constant of the LM62 is much slower than the 30 ms time constant formed by the RC, the overall response time of the LM62 will not be significantly affected. For much larger capacitors this additional time lag will increase the overall response time of the LM62.



## Applications Circuits

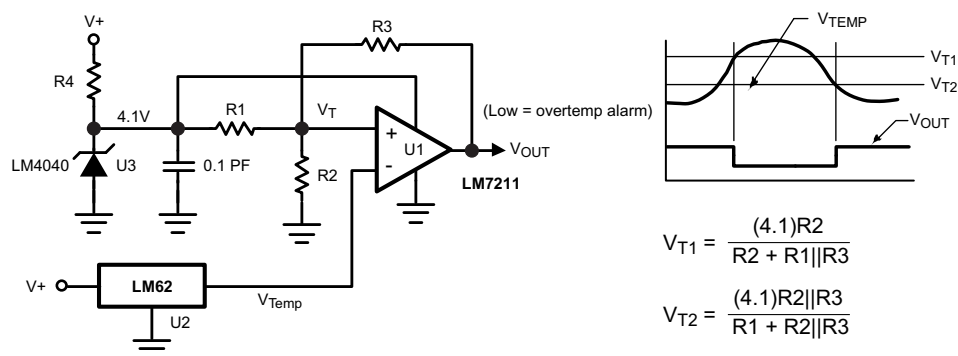


**Figure 16. Centigrade Thermostat**

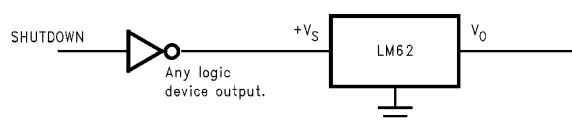


**Figure 17. Conserving Power Dissipation with Shutdown**

## REVISION HISTORY

| Changes from Revision D (March 2013) to Revision E         | Page              |
|------------------------------------------------------------|-------------------|
| • Changed layout of National Data Sheet to TI format ..... | <a href="#">8</a> |

## PACKAGING INFORMATION

| Orderable part number          | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|--------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">LM62BIM3/NOPB</a>  | Obsolete      | Production           | SOT-23 (DBZ)   3 | -                     | -           | Call TI                              | Call TI                           | 0 to 90      | T7B                 |
| <a href="#">LM62BIM3X/NOPB</a> | Active        | Production           | SOT-23 (DBZ)   3 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | 0 to 90      | T7B                 |
| LM62BIM3X/NOPB.A               | Active        | Production           | SOT-23 (DBZ)   3 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | 0 to 90      | T7B                 |
| LM62BIM3X/NOPB.B               | Active        | Production           | SOT-23 (DBZ)   3 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | 0 to 90      | T7B                 |
| <a href="#">LM62CIM3/NOPB</a>  | Obsolete      | Production           | SOT-23 (DBZ)   3 | -                     | -           | Call TI                              | Call TI                           | 0 to 90      | T7C                 |
| <a href="#">LM62CIM3X/NOPB</a> | Active        | Production           | SOT-23 (DBZ)   3 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | 0 to 90      | T7C                 |
| LM62CIM3X/NOPB.A               | Active        | Production           | SOT-23 (DBZ)   3 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | 0 to 90      | T7C                 |
| LM62CIM3X/NOPB.B               | Active        | Production           | SOT-23 (DBZ)   3 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | 0 to 90      | T7C                 |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

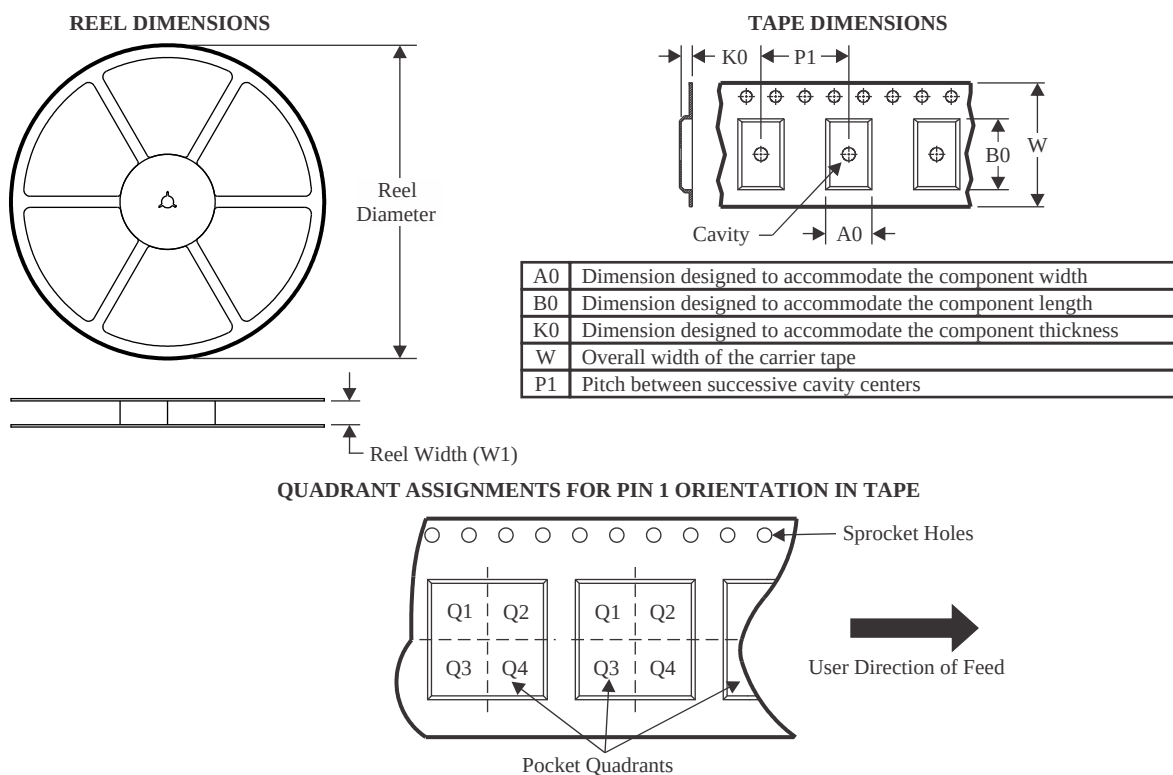
<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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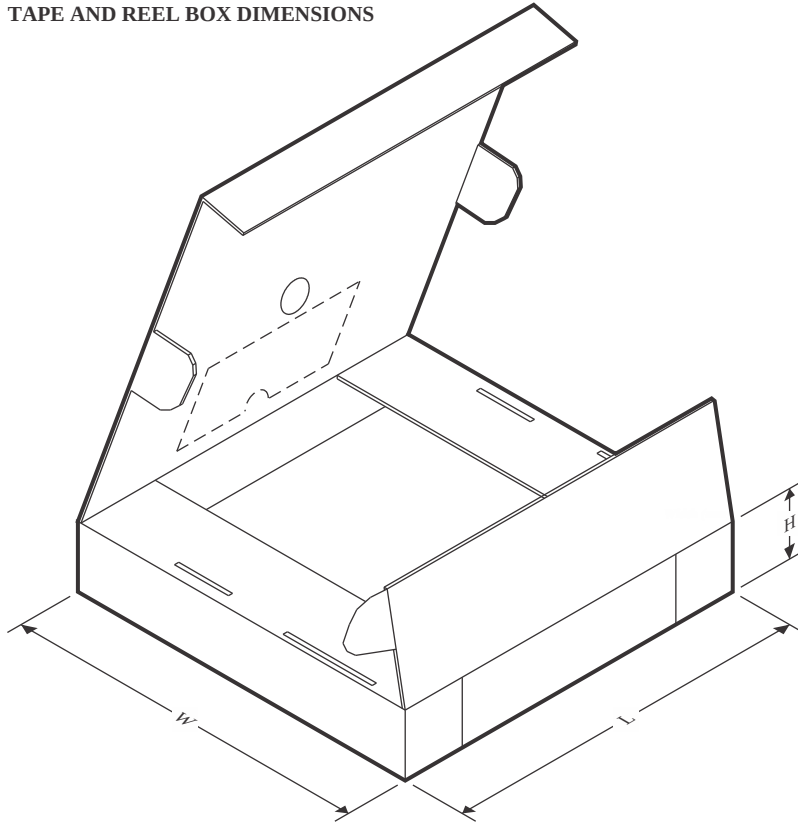
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

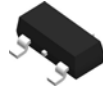
| Device         | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| LM62BIM3X/NOPB | SOT-23       | DBZ             | 3    | 3000 | 178.0              | 8.4                | 3.3     | 2.9     | 1.22    | 4.0     | 8.0    | Q3            |
| LM62CIM3X/NOPB | SOT-23       | DBZ             | 3    | 3000 | 178.0              | 8.4                | 3.3     | 2.9     | 1.22    | 4.0     | 8.0    | Q3            |

## TAPE AND REEL BOX DIMENSIONS

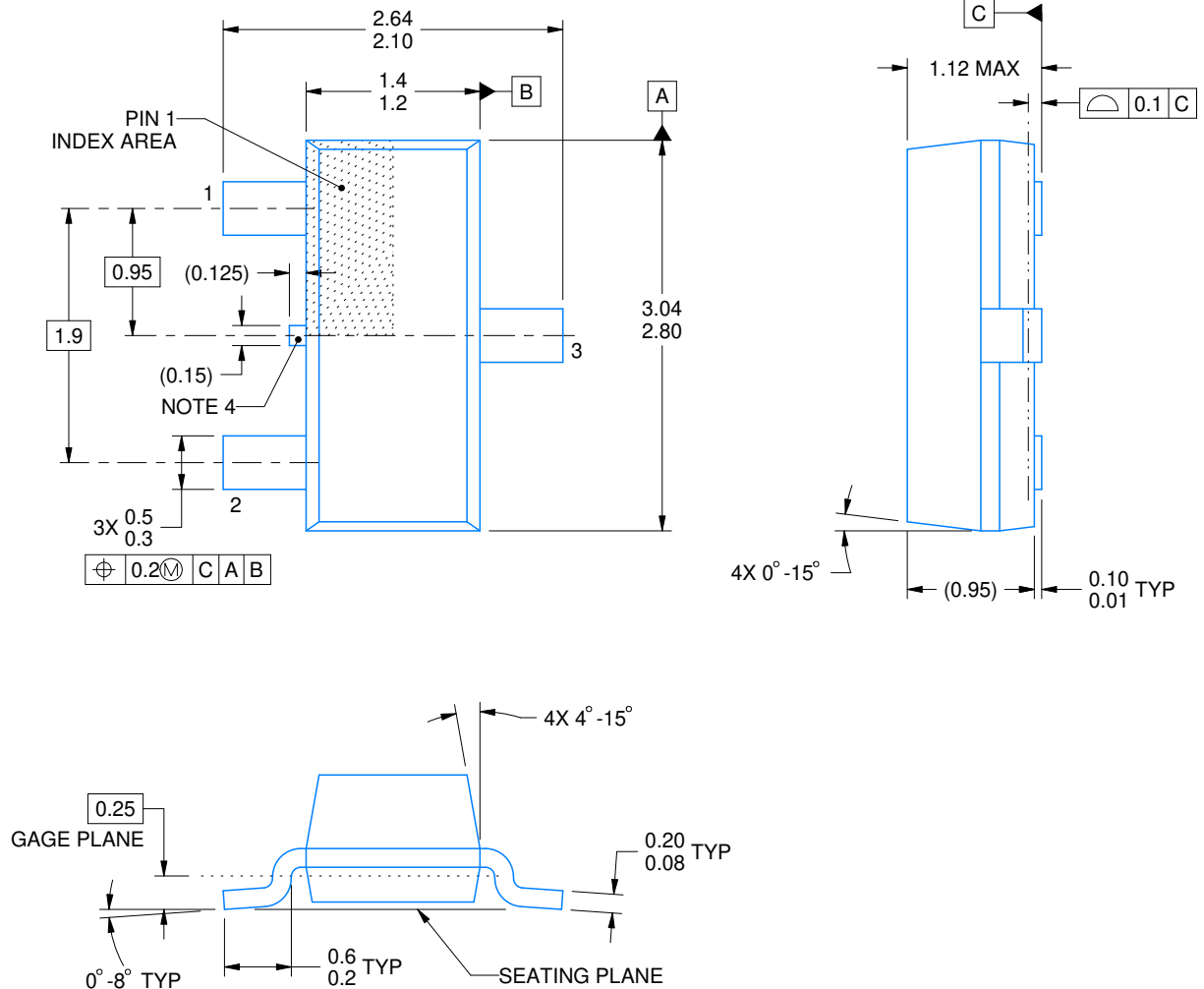


\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LM62BIM3X/NOPB | SOT-23       | DBZ             | 3    | 3000 | 208.0       | 191.0      | 35.0        |
| LM62CIM3X/NOPB | SOT-23       | DBZ             | 3    | 3000 | 208.0       | 191.0      | 35.0        |

**DBZ0003A****PACKAGE OUTLINE****SOT-23 - 1.12 mm max height**

SMALL OUTLINE TRANSISTOR



4214838/F 08/2024

**NOTES:**

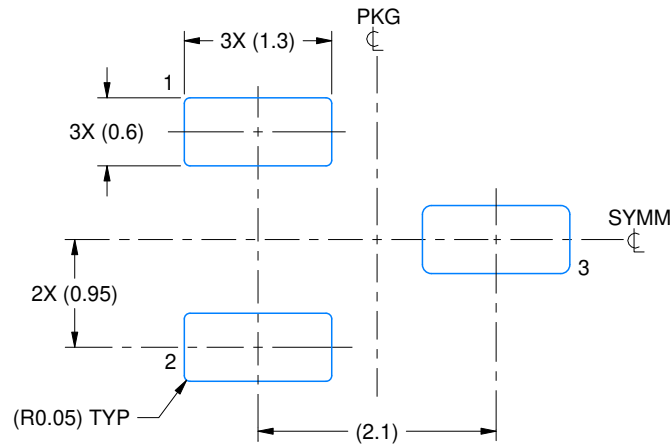
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC registration TO-236, except minimum foot length.
4. Support pin may differ or may not be present.
5. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25mm per side

# EXAMPLE BOARD LAYOUT

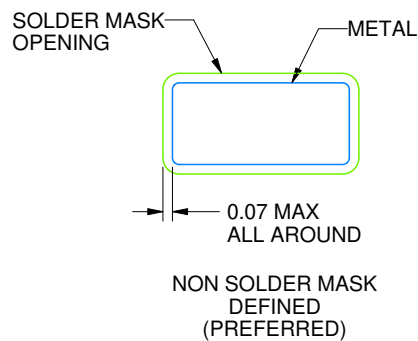
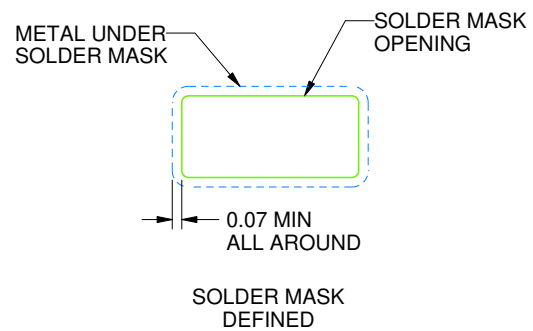
DBZ0003A

SOT-23 - 1.12 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
SCALE:15X



SOLDER MASK DETAILS

4214838/F 08/2024

NOTES: (continued)

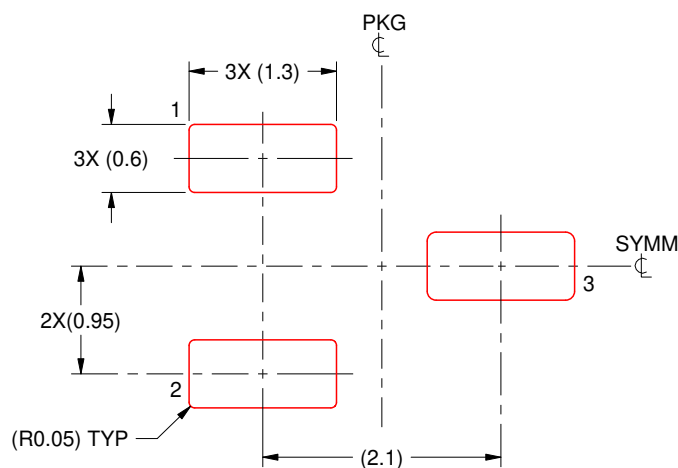
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DBZ0003A

SOT-23 - 1.12 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 THICK STENCIL  
SCALE:15X

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NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

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